# **NSEM**

MARKING

# **TinyLogic ULP-A NOR Gate**

# **NC7SP02**

The NC7SP02 is a single 2-input NOR gate in tiny footprint packages. The device is designed to operate for  $V_{CC} = 0.9$  V to 3.6 V.

### Features

- Designed for 0.9 V to 3.6 V V<sub>CC</sub> Operation
- 2.3 ns t<sub>PD</sub> at 3.3 V (Typ)
- Inputs/Outputs Over-Voltage Tolerant up to 3.6 V
- I<sub>OFF</sub> Supports Partial Power Down Protection
- Source/Sink 2.6 mA at 3.3 V
- Available in SC-88A and MicroPak<sup>™</sup> Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

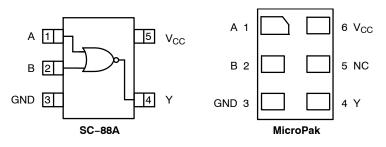


Figure 1. Pinout Diagrams (Top Views)

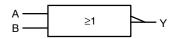


Figure 2. Logic Symbol

#### **PIN ASSIGNMENT**

Pin	SC88A	MicroPak
1	А	A
2	В	В
3	GND	GND
4	Y	Y
5	V <sub>CC</sub>	N.C.
6	_	V <sub>CC</sub>

N.C. = No Connect

#### DIAGRAMS SIP6 1.45X1.0 CCKK MicroPak XYZ CASE 127EB Pin 1 CC = Specific Device Code KK = 2-Digit Lot Run Traceability Code XY = 2-Digit Date Code Ζ

= Assembly Plant Code



XXX = Specific Device Code

- = Date Code Μ
  - = Pb-Free Package

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 6 of this data sheet.

ONCTION	IABLE
	Input

Inp	Output	
А	В	Y
L	L	Н
L	Н	L
н	L	L
Н	Н	L

### MAXIMUM RATINGS

Symbol	Characteristi	cs	Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +4.3	V
V <sub>IN</sub>	DC Input Voltage		-0.5 to +4.3	V
V <sub>OUT</sub>	DC Output Voltage	Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +4.3 -0.5 to +4.3	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < GND	-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	V <sub>OUT</sub> < GND	-50	mA
IOUT	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Ground	Pin	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Se	econds	260	°C
TJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 2)	SC-88A MicroPak	377 154	°C/W
P <sub>D</sub>	Power Dissipation in Still Air	SC-88A MicroPak	332 812	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
$V_{\text{ESD}}$	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 1000	V
I <sub>Latchup</sub>	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Applicable to devices with outputs that may be tri-stated.
 Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

4. Tested to EIA/JÉSD78 Class II.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Min	Max	Unit
V <sub>CC</sub>	Positive DC Supply Voltage		0.9	3.6	V
V <sub>IN</sub>	DC Input Voltage		0	3.6	V
V <sub>OUT</sub>	DC Output Voltage	Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V <sub>CC</sub> = 0 V)	0 0 0	V <sub>CC</sub> 3.6 3.6	
T <sub>A</sub>	Operating Temperature Range		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Transition Rise and Fall Time	$V_{CC}=3.3~V\pm0.3~V$	0	10	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

### DC ELECTRICAL CHARACTERISTICS

				T	<sub>A</sub> = 25°	С	T <sub>A</sub> = -40°C	C to +85°C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Мах	Unit
V <sub>IH</sub>	High-Level Input		0.9	-	0.5	-	-	-	V
	Voltage		1.1 to 1.3	$0.65 \times V_{CC}$	-	-	0.65 x V <sub>CC</sub>	-	
		1.4 to 1.6	0.65 x V <sub>CC</sub>	-	-	0.65 x V <sub>CC</sub>	_		
			1.65 to 1.95	$0.65 \times V_{CC}$	-	-	0.65 x V <sub>CC</sub>	-	
			2.3 to 2.7	1.6	-	-	1.6	-	
			3.0 to 3.6	2.1	-	-	2.1	-	
VIL	Low-Level Input		0.9	-	0.5	-	-	-	V
	Voltage		1.1 to 1.3	_	-	0.35 x V <sub>CC</sub>	-	$0.35 \times V_{CC}$	
			1.4 to 1.6	_	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	
			1.65 to 1.95	_	-	0.35 x V <sub>CC</sub>	-	$0.35 \times V_{CC}$	
			2.3 to 2.7	-	-	0.7	-	0.7	
			3.0 to 3.6	_	-	0.9	-	0.9	
V <sub>OH</sub>	High-Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Voltage	I <sub>OH</sub> = -20 μA	0.9	-	V <sub>CC</sub> - 0.1	-	-	-	
			1.1 to 1.3	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
			1.4 to 1.6	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	_	
			1.65 to 1.95	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	_	
			2.3 to 2.7	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
			3.0 to 3.6	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
		I <sub>OH</sub> = -0.5 mA	1.1 to 1.3	$0.75 \ x \ V_{CC}$	-	-	$0.70 \times V_{CC}$	-	
		I <sub>OH</sub> = -1 mA	1.4 to 1.6	1.07	-	-	0.99	-	
		I <sub>OH</sub> = -1.5 mA	1.65 to 1.95	1.24	-	-	1.22	-	
		I <sub>OH</sub> = -2.1 mA	2.3 to 2.7	1.95	-	-	1.87	_	
		I <sub>OH</sub> = -2.6 mA	3.0 to 3.6	2.61	-	-	2.55	-	
$V_{OL}$	Low-Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Voltage	I <sub>OL</sub> = 20 μA	0.9	_	0.1	-	-	_	
			1.1 to 1.3	-	-	0.1	-	0.1	
			1.4 to 1.6	_	-	0.1	-	0.1	
			1.65 to 1.95	-	-	0.1	-	0.1	
			2.3 to 2.7	-	-	0.1	-	0.1	
			3.0 to 3.6	-	-	0.1	-	0.1	
		I <sub>OL</sub> = 0.5 mA	1.1 to 1.3	-	-	$0.3 \times V_{CC}$	-	$0.3 \times V_{CC}$	
		I <sub>OL</sub> = 1 mA	1.4 to 1.6	-	-	0.31	-	0.37	
		I <sub>OL</sub> = 1.5 mA	1.65 to 1.95	-	-	0.31	-	0.35	
		I <sub>OL</sub> = 2.1 mA	2.3 to 2.7	-	_	0.31	-	0.33	
		I <sub>OL</sub> = 2.6 mA	3.0 to 3.6	-	-	0.31	-	0.33	
I <sub>IN</sub>	Input Leakage Current	V <sub>IN</sub> = 0 V to 3.6 V	0.9 to 3.6	-	-	±0.1	-	±0.5	μA
I <sub>OFF</sub>	Power Off Leakage Current	$V_{IN} = 0 V \text{ to } 3.6 V \text{ or}$ $V_{OUT} = 0 V \text{ to } 3.6 V$	0	-	-	0.5	-	0.5	μA
I <sub>CC</sub>	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	0.9 to 3.6	_	_	0.9	-	0.9	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

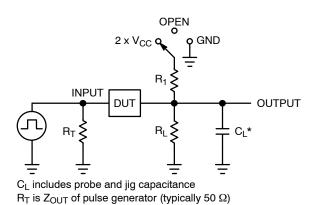
#### AC ELECTRICAL CHARACTERISTICS

				٦	Γ <sub>A</sub> = 25°0	2	T <sub>A</sub> = -40°C	C to +85°C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	$R_L = 1 M\Omega$ , $C_L = 10 pF$	0.9	-	40.2	-	-	-	ns
	(A or B) to Y (Figures 3 and 4)		1.10 to 1.30	-	10.1	24.4	-	30.9	
			1.40 to 1.60	-	5.5	12.4	-	13.9	
			1.65 to 1.95	-	4.4	9.6	-	12.1	
			2.3 to 2.7	-	3.8	7.0	-	8.0	
			3.0 to 3.6	-	2.3	5.7	-	6.9	
t <sub>PLH</sub> , t <sub>PHL</sub>		$R_L = 1 M\Omega$ , $C_L = 15 pF$	0.9	-	42.2	-	-	-	ns
	(A or B) to Y (Figures 3 and 4)		1.10 to 1.30	-	11.0	25.4	-	33.9	
			1.40 to 1.60	-	6.0	13.3	-	13.9	
			1.65 to 1.95	-	4.7	10.3	-	12.6	
			2.3 to 2.7	-	3.8	7.4	-	8.2	
			3.0 to 3.6	-	2.5	6.1	-	7.0	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	$R_L = 1 M\Omega$ , $C_L = 30 pF$	0.9	-	48.2	-	-	-	ns
	(A or B) to Y (Figures 3 and 4)		1.10 to 1.30	-	13.7	28.2	-	43.0	
			1.40 to 1.60	-	7.7	16.0	-	18.0	
			1.65 to 1.95	-	5.6	12.0	-	14.0	
			2.3 to 2.7	-	3.9	9.0	-	10.0	
			3.0 to 3.6	-	3.0	7.0	-	8.9	

#### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Test Condition	Typical (T <sub>A</sub> = 25°C)	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = 0 V	2.0	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>CC</sub> = 0 V	4.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 5)	f = 10 MHz, $V_{CC}$ = 0.9 to 3.6 V, $V_{IN}$ = 0 V or $V_{CC}$	6.0	pF

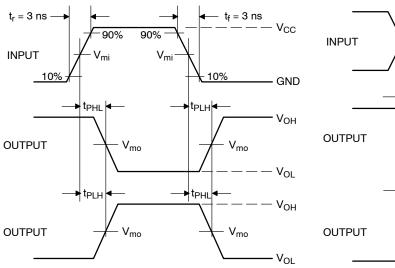
5.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation  $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$ .  $C_{PD}$  is used to determine the no–load dynamic power consumption:  $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$ .

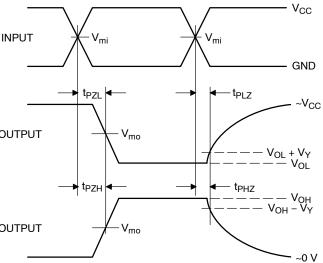


f = 1 MHz

Test	Switch Position
t <sub>PLH</sub> / t <sub>PHL</sub>	Open
t <sub>PLZ</sub> / t <sub>PZL</sub>	2 x V <sub>CC</sub>
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND

Figure 3. Test Circuit





V <sub>CC</sub> , V	V <sub>mi</sub> , V	V <sub>mo</sub> , V	V <sub>Y</sub> , V
0.9	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.1
1.1 to 1.3	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.1
1.4 to 1.6	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.1
1.65 to 1.95	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.15
2.3 to 2.7	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.15
3.0 to 3.6	1.5	1.5	0.3

Figure 4. Switching Waveforms

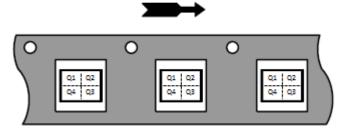
#### **ORDERING INFORMATION**

Device	Package	Marking	Pin 1 Orientation (See below)	Shipping <sup>†</sup>
NC7SP02P5X	SC-88A	P02	Q4	3000 / Tape & Reel
NC7SP02L6X	MicroPak	J5	Q4	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## Pin 1 Orientation in Tape and Reel

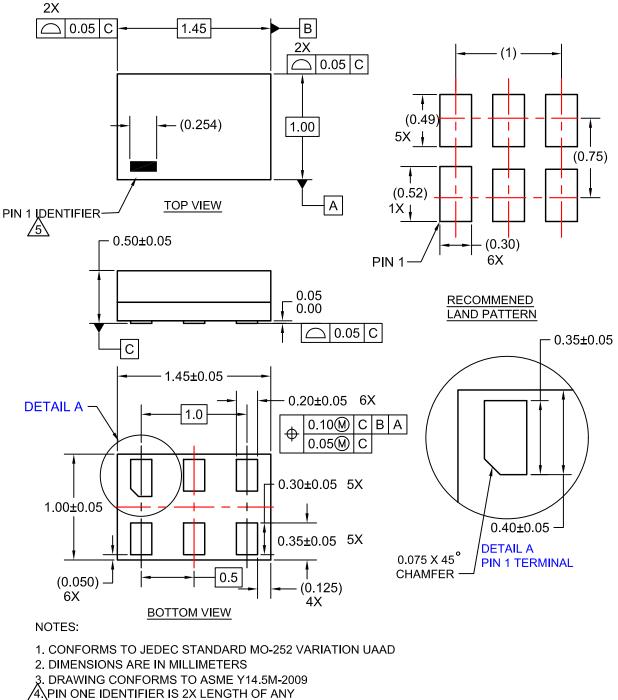
# Direction of Feed



MicroPak is a trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

#### PACKAGE DIMENSIONS

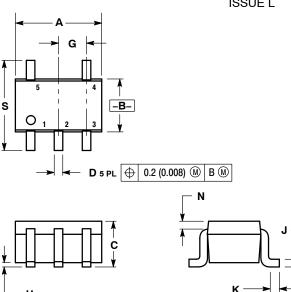
SIP6 1.45X1.0 CASE 127EB ISSUE O



OTHER LINE IN THE MARK CODE LAYOUT.

#### PACKAGE DIMENSIONS

SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE L



NOTES:

1. DIMENSIONING AND TOLERANCING

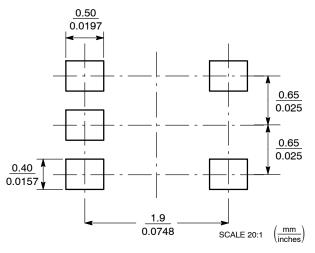
PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

 419A–01 OBSOLETE. NEW STANDARD 419A–02

 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026	BSC	0.65 BSC	
Н		0.004		0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008	0.008 REF		REF
S	0.079	0.087	2.00	2.20

#### SOLDER FOOTPRINT



onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters, including "Typicals" must be validated for each customer applications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights or the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** produc

#### PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

#### TECHNICAL SUPPORT

Email Requests to: orderlit@onsemi.com
onsemi Website: www.onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Logic Gates category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

74HC85N NLU1G32AMUTCG NLV7SZ58DFT2G CD4068BE NL17SG32P5T5G NL17SG86DFT2G NLV14001UBDR2G NLX1G11AMUTCG NLX1G97MUTCG 74LS38 74LVC32ADTR2G MC74HCT20ADTR2G NLV17SZ00DFT2G NLV17SZ02DFT2G NLV74HC02ADR2G 74HC32S14-13 74LS133 74LVC1G32Z-7 M38510/30402BDA 74LVC1G86Z-7 74LVC2G08RA3-7 NLV74HC08ADTR2G NLV74HC14ADR2G NLV74HC20ADR2G NLX2G86MUTCG 5962-8973601DA 74LVC2G02HD4-7 NLU1G00AMUTCG 74LVC2G32RA3-7 74LVC2G00HD4-7 NL17SG02P5T5G 74LVC2G00HK3-7 74LVC2G86HK3-7 NLX1G99DMUTWG NLVVHC1G00DFT2G NLVHC1G08DFT2G NLV7SZ57DFT2G NLV74VHC04DTR2G NLV27WZ86USG NLV27WZ00USG NLU1G86CMUTCG NLU1G08CMUTCG NL17SZ32P5T5G NL17SZ00P5T5G NL17SH02P5T5G 74AUP2G00RA3-7 NLV74HC02ADTR2G NLX1G332CMUTCG NL17SG86P5T5G NL17SZ05P5T5G